

# KWD5

## RELIABILITY DATA

### 信頼性データ

No. RD-08T-642A		
承認	査閲	担当
Kinosawa 31.Oct.'08	Y.Kihara 30.Oct.'08	M.Nogai 30.Oct.'08

## I N D E X

	PAGE
1. MTBF 計算値 Calculated Values of MTBF .....	2/40
2. 部品ディレーティング Component Derating .....	3/40～6/40
3. 部品温度上昇値 Components Temperature Rise $\Delta T$ List .....	7/40
4. 電解コンデンサ推定寿命計算値 Electrolytic Capacitor Lifetime Versus Load .....	8/40～17/40
5. アブノーマル試験 Abnormal Test .....	18/40～32/40
6. 振動試験 Vibration Test .....	33/40～34/40
7. ノイズシミュレート試験 Noise Simulate Test .....	35/40
8. 静電気シミュレート試験 Electro-Static Discharge Test .....	36/40
9. 雷サージ試験 Impulse Test .....	37/40
10. 雑音端子電圧 EMI Test .....	38/40～40/40

※信頼性試験は代表データであり、この値は実力値とお考え願います。

※本データに掲載しております内蔵部品の名称は、本製品を開発した当初のものです。

これらは改善等の為に変更されている可能性もありますが、ご了承下さい。

The following data are typical values and the data to be considered as ability values.  
 The built-in components names on this data are the things the time of Development.  
 Please understand that it may be changed for an improvement etc.

M . T . B . F

## 1. Method of calculation

This calculation is by the components count method laid down by the DC Stabilized Power Supplies (Switching mode) committee of EIAJ.

The MTBF is determined by means of a fixed component failure rate  $\lambda_c$  given to each component and the number of component count of each type of component.  $\lambda_c$  is determined based on MIL-HDBK-217D.

Please refer to the EIAJ handbook no. RCF-9021 for detail.

Formula:

$$\text{MTBF} = \frac{1}{\lambda_{\text{equip}}} = \frac{1}{\sum_i^n N_i(\lambda_c)_i} \times 10^6 \text{ (Hrs)}$$

$\lambda_{\text{equip}}$  = Total equipment failure rate (Failures/10<sup>6</sup>hrs)

$\lambda_c$  = Failure rate of the  $i^{th}$  component

$N_i$  = Number of  $i^{th}$  component

$n$  = Number of categories of components

## 2. MTBF Value

Condition : Nominal line, rated load

Ambient Temperature 25°C

---

MTBF = 91,735 hrs.

---

Components Derating Data(At Nominal Line and Rated Load, Ambient Temperature 50°C)Calculation Method**A. Semiconductors**

The derating factor is taken as the ratio of the actual operating junction temperature taking into consideration operating ambient temperature, power loss and thermal resistance to the maximum rated junction temperature specifications of the components.

**B. IC, Resistors, Capacitors etc.**

Operating ambient temperature, operating condition, power loss for each individual component are all designed to meet the requirements of Nemic-Lambda's design standard.

**C. Thermal Resistance Calculation**

$$\theta_{jc} = \frac{T_j(\max) - T_c}{P_c(\max)}$$

$$\theta_{ja} = \frac{T_j(\max) - T_a}{P_c(\max)}$$

Tc : Case Temperature (Normally 25°C)

Ta : Ambient Temperature (Normally 25°C)

Pc(max) : Maximum Power Loss

Tj(max) : Maximum Junction Temperature

$\theta_{jc}$  : Junction to Case Thermal Resistance

$\theta_{ja}$  : Junction to ambient Thermal Resistance

認 APPD		設 計 ENGR		図面番号 DWG-No. PA773-56-02 - <span style="border: 1px solid black; padding: 2px;">  </span>
検 C H K		製 図 DWG		

SEMICONDUCTOR DERATING

4  
40

DWG. NO. : PA773-56-03

DATE : 6-DEC-92

MODEL : KWD5-1212

VIN = AC 100V

LOAD = 100%

T<sub>a</sub> = 50°C

Q1 2SK1533 FUJI	T <sub>chmax</sub> = 150 °C $\theta_{ch-c}$ = 1.563 °C/W      P <sub>dmax</sub> = 80 W
	P <sub>d</sub> = 0.57 W $\Delta T_c$ = 31.3 °C      T <sub>c</sub> = 81.3 °C
	T <sub>j</sub> = T <sub>c</sub> + ( $\theta_{ch-c}$ ) * P <sub>d</sub> = 82.2 °C
	D.F. = 54.8 %
Q2 2SC2712 TOSHIBA	T <sub>jmax</sub> = 150 °C $\theta_{j-c}$ = 125 °C/W      P <sub>dmax</sub> = 1 W
	P <sub>d</sub> = 0.0 W $\Delta T_c$ = 31.3 °C      T <sub>c</sub> = 81.3 °C
	T <sub>j</sub> = T <sub>c</sub> + ( $\theta_{j-c}$ ) * P <sub>d</sub> = 81.3 °C
	D.F. = 54.2 %
A1 UC2842ADW UNITRODE	T <sub>jmax</sub> = 150 °C $\theta_{j-c}$ = 70 °C/W      P <sub>dmax</sub> = 0.725 W
	P <sub>d</sub> = 0.383 W $\Delta T_c$ = 34.2 °C      T <sub>c</sub> = 84.2 °C
	T <sub>j</sub> = T <sub>c</sub> + ( $\theta_{j-c}$ ) * P <sub>d</sub> = 111.0 °C
	D.F. = 74.0 %
A2 HA17431UA HITACHI	T <sub>jmax</sub> = 125 °C $\theta_{j-c}$ = 259.7 °C/W      P <sub>dmax</sub> = 0.385 W
	P <sub>d</sub> = 15.6 mW $\Delta T_c$ = 24.0 °C      T <sub>c</sub> = 74.0 °C
	T <sub>j</sub> = T <sub>c</sub> + ( $\theta_{j-c}$ ) * P <sub>d</sub> = 78.1 °C
	D.F. = 62.5 %
PC1 (LED) TLP121GR TOSHIBA	T <sub>jmax</sub> = 125 °C $\theta_{j-c}$ = 400 °C/W      P <sub>dmax</sub> = 50 mW
	I <sub>f</sub> = 1.0 mA $\Delta T_c$ = 25.4 °C      T <sub>c</sub> = 75.4 °C
	ALLOWABLE I <sub>f</sub> (max) = 35.0 mA (at 75.4 °C)
	D.F. = 2.9 %
PC1 (TRANSISTOR) TLP121GR TOSHIBA	T <sub>jmax</sub> = 125 °C $\theta_{j-c}$ = 400 °C/W      P <sub>dmax</sub> = 150 mW
	P <sub>d</sub> = 5.4 mW $\Delta T_c$ = 25.4 °C      T <sub>c</sub> = 75.4 °C
	T <sub>j</sub> = T <sub>c</sub> + ( $\theta_{j-c}$ ) * P <sub>d</sub> = 77.6 °C
	D.F. = 62.0 %
D1 S1WB(A)60B SHINDENGEN	T <sub>jmax</sub> = 150 °C $\theta_{j-l}$ = 10 °C/W      P <sub>dmax</sub> = 12.5 W
	P <sub>d</sub> = 0.213 W $\Delta T_l$ = 20.7 °C      T(lead) = 70.7 °C
	T <sub>j</sub> = T <sub>l</sub> + ( $\theta_{j-l}$ ) * P <sub>d</sub> = 72.8 °C
	D.F. = 48.6 %

SEMICONDUCTOR DERATING

5  
40

DWG. NO. : PA773-56-04

DATE : 6-DEC-92

MODEL : KWD5-1212

VIN = AC 100V

LOAD = 100%

T<sub>a</sub> = 50°C

D2 EC8FS6 NIHON-INTER	T <sub>jmax</sub> = 150 °C      Θ <sub>j-I</sub> = 23 °C/W      P <sub>dmax</sub> = 5.43 W
	P <sub>d</sub> = 25.0 mW      ΔT = 27.3 °C      T(lead) = 77.3 °C
	T <sub>j</sub> = T <sub>I</sub> + (Θ <sub>j-I</sub> ) * P <sub>d</sub> = 77.9 °C
	D.F. = 51.9 %
D3 1SS184TE85L TOSHIBA	T <sub>jmax</sub> = 125 °C      Θ <sub>j-I</sub> = 100 °C/W      P <sub>dmax</sub> = 150 mW
	P <sub>d</sub> = 0.0 W      ΔT = 31.0 °C      T(lead) = 81.0 °C
	T <sub>j</sub> = T <sub>I</sub> + (Θ <sub>j-I</sub> ) * P <sub>d</sub> = 81.0 °C
	D.F. = 64.8 %
D4 1SS184TE85L TOSHIBA	T <sub>jmax</sub> = 125 °C      Θ <sub>j-I</sub> = 100 °C/W      P <sub>dmax</sub> = 150 mW
	P <sub>d</sub> = 5.8 mW      ΔT = 26.0 °C      T(lead) = 76.0 °C
	T <sub>j</sub> = T <sub>I</sub> + (Θ <sub>j-I</sub> ) * P <sub>d</sub> = 76.6 °C
	D.F. = 61.3 %
D5 D1FL20U SHINDENGEN	T <sub>jmax</sub> = 150 °C      Θ <sub>j-I</sub> = 23 °C/W      P <sub>dmax</sub> = 5.43 W
	P <sub>d</sub> = 30.0 mW      ΔT = 28.8 °C      T(lead) = 78.8 °C
	T <sub>j</sub> = T <sub>I</sub> + (Θ <sub>j-I</sub> ) * P <sub>d</sub> = 79.5 °C
	D.F. = 53.0 %
D6 D1FL20U SHINDENGEN	T <sub>jmax</sub> = 150 °C      Θ <sub>j-I</sub> = 23 °C/W      P <sub>dmax</sub> = 5.43 W
	P <sub>d</sub> = 0.108 W      ΔT = 30.9 °C      T(lead) = 80.9 °C
	T <sub>j</sub> = T <sub>I</sub> + (Θ <sub>j-I</sub> ) * P <sub>d</sub> = 83.4 °C
	D.F. = 55.6 %
D7 D1FL20U SHINDENGEN	T <sub>jmax</sub> = 150 °C      Θ <sub>j-I</sub> = 23 °C/W      P <sub>dmax</sub> = 5.43 W
	P <sub>d</sub> = 0.108 W      ΔT = 30.9 °C      T(lead) = 80.9 °C
	T <sub>j</sub> = T <sub>I</sub> + (Θ <sub>j-I</sub> ) * P <sub>d</sub> = 83.4 °C
	D.F. = 55.6 %
D10 D1FL20U SHINDENGEN	T <sub>jmax</sub> = 150 °C      Θ <sub>j-I</sub> = 23 °C/W      P <sub>dmax</sub> = 5.43 W
	P <sub>d</sub> = 0.108 W      ΔT = 31.8 °C      T(lead) = 81.8 °C
	T <sub>j</sub> = T <sub>I</sub> + (Θ <sub>j-I</sub> ) * P <sub>d</sub> = 84.3 °C
	D.F. = 56.2 %

SEMICONDUCTOR DERATING

6  
40

DWG. NO. : PA773-56-05

DATE : 6-DEC-92

MODEL : KWD5-1212

VIN = AC 100V

LOAD = 100%

T<sub>a</sub> = 50°C

D11 D1FL20U SHINDENGEN	T <sub>jmax</sub> = 150 °C	Θ <sub>j-I</sub> = 23 °C/W	P <sub>dmax</sub> = 5.43 W
	P <sub>d</sub> = 0.108 W	Δ T <sub>I</sub> = 31.8 °C	T(lead) = 81.8 °C
	T <sub>j</sub> = T <sub>I</sub> + (Θ <sub>j-I</sub> ) * P <sub>d</sub> =	84.3 °C	
	D.F. = 56.2 %		
ZD1 1N4744A MOTOROLA	T <sub>jmax</sub> = 200 °C	Θ <sub>j-I</sub> = 175 °C/W	P <sub>dmax</sub> = 1 W
	P <sub>d</sub> = 0.0 W	Δ T <sub>I</sub> = 25.5 °C	T(lead) = 75.5 °C
	T <sub>j</sub> = T <sub>I</sub> + (Θ <sub>j-I</sub> ) * P <sub>d</sub> =	75.5 °C	
	D.F. = 37.8 %		
ZD2 02CZ12-Z TOSHIBA	T <sub>jmax</sub> = 150 °C	Θ <sub>j-I</sub> = 100 °C/W	P <sub>dmax</sub> = 150 mW
	P <sub>d</sub> = 19.0 mW	Δ T <sub>I</sub> = 29.1 °C	T(lead) = 79.1 °C
	T <sub>j</sub> = T <sub>I</sub> + (Θ <sub>j-I</sub> ) * P <sub>d</sub> =	81.0 °C	
	D.F. = 54.0 %		

TDK-Lambda

$\Delta T$  TEMPERATURE RISE

DWG. NO. PA773-66-02

MODEL : KWD5-1212

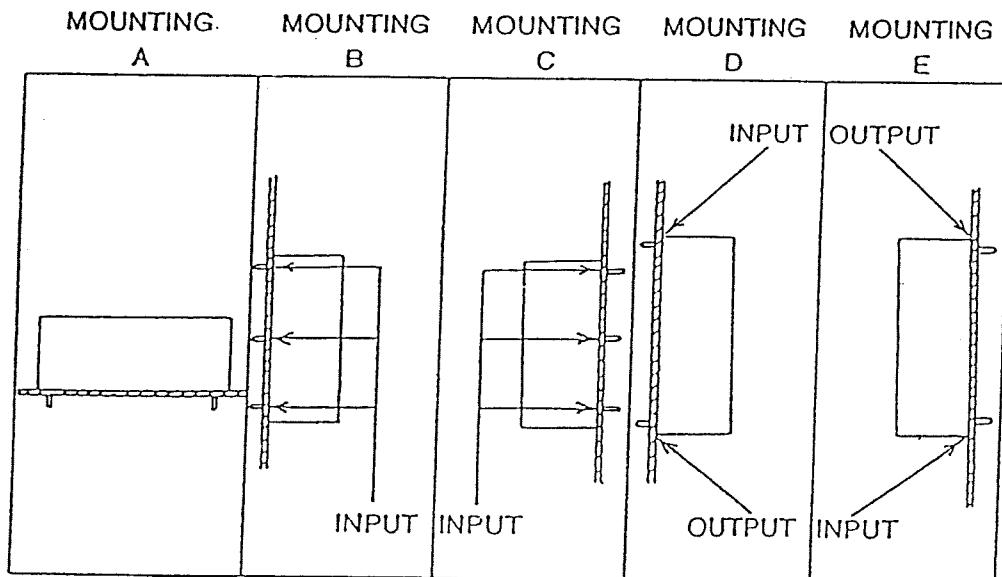
DATE : 6-DEC-92

INPUT VOLTAGE = 100VAC

Ta = 50°C		$\Delta T$ TEMPERATURE RISE (°C)				
OUTPUT DERATING (%)		100%	100%	100%	100%	100%
SYMBOL	PARTS NAME	MOUNTING A	MOUNTING B	MOUNTING C	MOUNTING D	MOUNTING E
Q1	MOSFET	31.3	31.0	30.0	30.2	29.7
A1	PWM IC	34.2	34.5	33.9	34.5	33.7
D6	UFRD	30.9	28.6	29.0	27.4	29.1
D11	UFRD	31.8	32.2	31.9	32.0	32.1
C6	E. CAP	24.3	25.3	23.4	24.0	24.1
C18	OS CAP	24.6	23.8	23.7	22.6	25.2
C21	OS CAP	24.2	24.1	22.6	22.2	24.6

INPUT VOLTAGE = 200VAC

Ta = 50°C		$\Delta T$ TEMPERATURE RISE (°C)				
OUTPUT DERATING (%)		100%	100%	100%	100%	100%
SYMBOL	PARTS NAME	MOUNTING A	MOUNTING B	MOUNTING C	MOUNTING D	MOUNTING E
Q1	MOSFET	44.2	45.8	47.6	45.5	47.0
A1	PWM IC	42.0	41.1	42.0	42.0	41.8
D6	UFRD	36.0	36.2	35.5	35.4	35.3
D11	UFRD	37.2	38.0	37.9	38.0	37.1
C6	E. CAP	31.3	31.9	34.1	30.4	32.5
C18	OS CAP	29.3	31.8	30.7	29.6	30.2
C21	OS CAP	28.7	31.0	30.9	28.0	29.8



## ELECTROLYTIC CAPACITOR LIFETIME VERSUS LOAD

MODEL : KWD5-1212

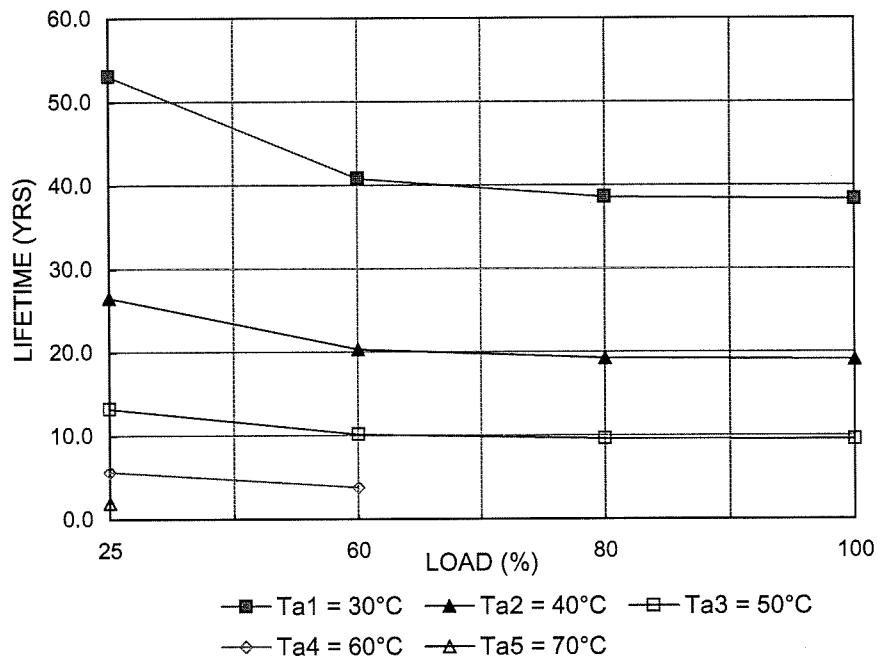
MOUNTING : A

VIN : 100VAC

DATE: SEPT 12, 2008

LOAD (%)	LIFETIME (YRS)				
	Ta = 30°C	Ta = 40°C	Ta = 50°C	Ta = 60°C	Ta = 70°C
25	53.1	26.6	13.3	5.7	2.0
60	40.8	20.4	10.2	3.8	
80	38.6	19.3	9.7		
100	38.3	19.2	9.6		

GRAPH OF ELECTROLYTIC CAPACITOR LIFETIME VS LOAD  
MOUNTING A KWD5-1212



### 計算式 FORMULA

- |  |        |  |
|--|--------|--|
| 1. アルミ電解コンデンサ<br>AL. Electrolytic capacitor<br>$L = Lo \times 2^{(105-Tc)/10}$ | $L$ :  | 電解コンデンサ推定寿命計算値<br>Elec. Capacitor computed life.<br>(24時間連続稼動、365日)<br>(24 hrs per day, 365 days per year) |
| 2. OSコンデンサ<br>O.S capacitor<br>$L = Lo \times 10^{(105-Tc)/22}$                | $Lo$ : | 電解コンデンサ保証寿命値<br>Guarantee life for Elec. cap.  |
|  | $Tc$ : | 電解コンデンサのケース温度<br>Case temperature of Elec. cap.  |

## ELECTROLYTIC CAPACITOR LIFETIME VERSUS LOAD

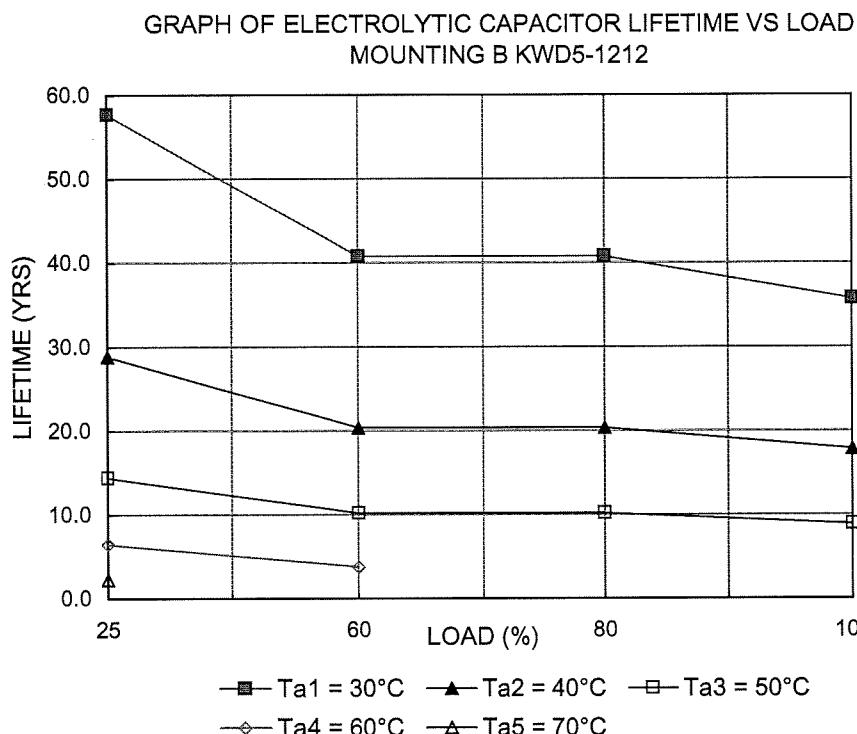
MODEL : KWD5-1212

MOUNTING : B

VIN : 100VAC

DATE: SEPT 12, 2008

LOAD (%)	LIFETIME (YRS)				
	Ta = 30°C	Ta = 40°C	Ta = 50°C	Ta = 60°C	Ta = 70°C
25	57.7	28.9	14.4	6.5	2.3
60	40.8	20.4	10.2	3.8	
80	40.8	20.4	10.2		
100	35.8	17.9	8.9		



### 計算式 FORMULA

1. アルミ電解コンデンサ  
AL. Electrolytic capacitor

$$L = Lo \times 2^{(105-T_c)/10} \quad (\text{year})$$

L : 電解コンデンサ推定寿命計算値  
Elec. Capacitor computed life.

(24時間連続稼動、365日)  
(24 hrs per day, 365 days per year)

2. OSコンデンサ

O.S capacitor

$$L = Lo \times 10^{(105-T_c)/22} \quad (\text{year})$$

Lo : 電解コンデンサ保証寿命値

Guarantee life for Elec. cap.

Tc : 電解コンデンサのケース温度

Case temperature of Elec. cap.

## ELECTROLYTIC CAPACITOR LIFETIME VERSUS LOAD

MODEL : KWD5-1212

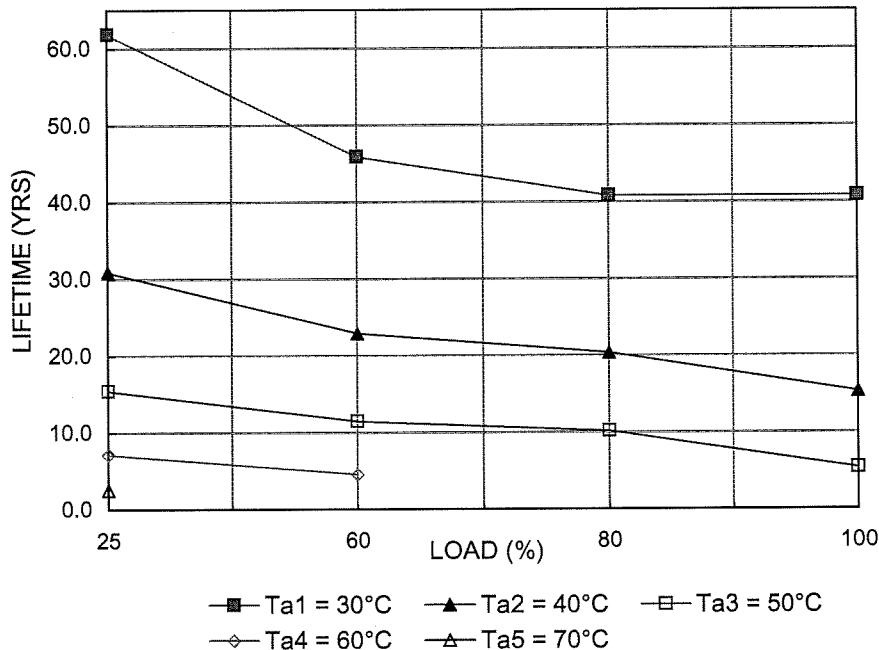
MOUNTING : C

VIN : 100VAC

DATE: SEPT 12, 2008

LOAD (%)	LIFETIME (YRS)				
	Ta = 30°C	Ta = 40°C	Ta = 50°C	Ta = 60°C	Ta = 70°C
25	61.9	30.9	15.5	7.2	2.5
60	45.9	23.0	11.5	4.6	
80	40.8	20.4	10.2		
100	40.8	15.4	5.4		

GRAPH OF ELECTROLYTIC CAPACITOR LIFETIME VS LOAD  
MOUNTING C KWD5-1212



### 計算式 FORMULA

#### 1. アルミ電解コンデンサ

AL. Electrolytic capacitor

$$L = Lo \times 2^{(105-Tc)/10} \quad (\text{year})$$

L : 電解コンデンサ推定寿命計算値

Elec. Capacitor computed life.

(24時間連続稼動、365日)

(24 hrs per day, 365 days per year)

#### 2. OSコンデンサ

O.S capacitor

$$L = Lo \times 10^{(105-Tc)/22} \quad (\text{year})$$

Lo : 電解コンデンサ保証寿命値

Guarantee life for Elec. cap.

Tc : 電解コンデンサのケース温度

Case temperature of Elec. cap.

## ELECTROLYTIC CAPACITOR LIFETIME VERSUS LOAD

MODEL : KWD5-1212

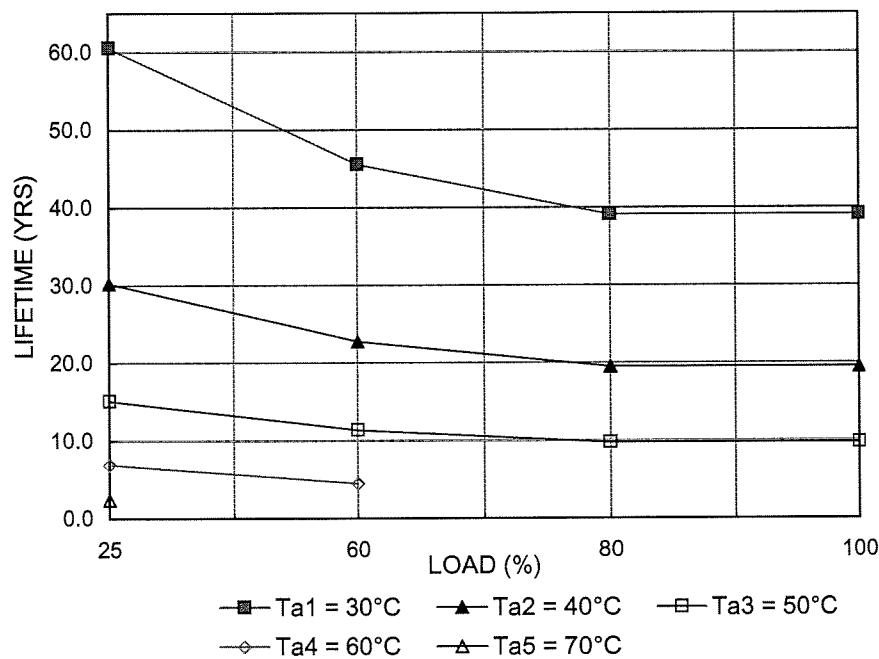
MOUNTING : D

VIN : 100VAC

DATE: SEPT 12, 2008

LOAD (%)	LIFETIME (YRS)				
	Ta = 30°C	Ta = 40°C	Ta = 50°C	Ta = 60°C	Ta = 70°C
25	60.6	30.3	15.1	7.0	2.4
60	45.6	22.8	11.4	4.5	
80	39.2	19.6	9.8		
100	39.2	19.6	9.8		

GRAPH OF ELECTROLYTIC CAPACITOR LIFETIME VS LOAD  
MOUNTING D KWD5-1212



### 計算式 FORMULA

1. アルミ電解コンデンサ  
AL. Electrolytic capacitor  
 $L = Lo \times 2^{(105-Tc)/10}$  (year)
2. OSコンデンサ  
O.S capacitor  
 $L = Lo \times 10^{(105-Tc)/22}$  (year)
- L : 電解コンデンサ推定寿命計算値  
Elec. Capacitor computed life.  
(24時間連続稼動、365日)  
(24 hrs per day, 365 days per year)
- Lo : 電解コンデンサ保証寿命値  
Guarantee life for Elec. cap.
- Tc : 電解コンデンサのケース温度  
Case temperature of Elec. cap.

## ELECTROLYTIC CAPACITOR LIFETIME VERSUS LOAD

MODEL : KWD5-1212

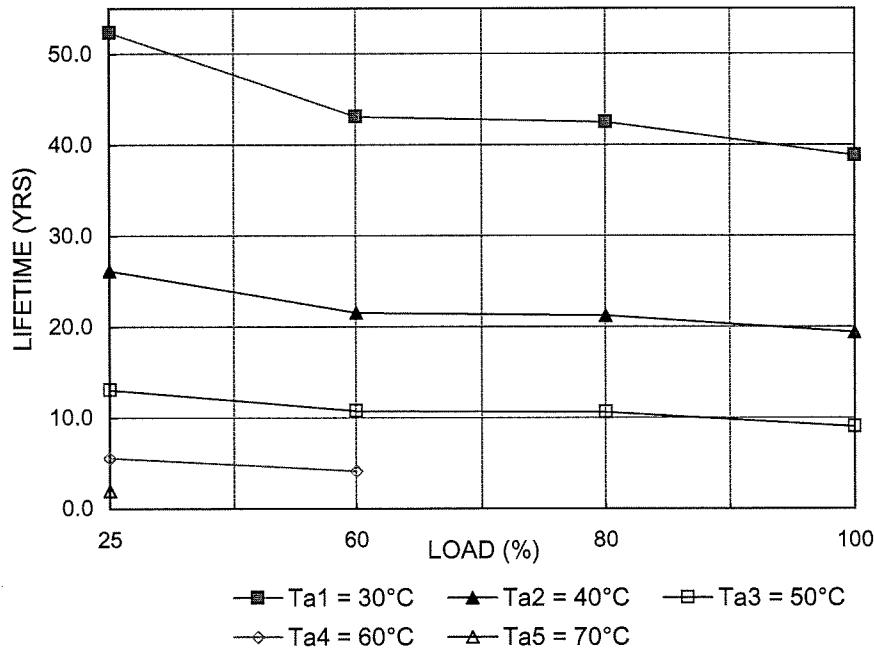
MOUNTING : E

VIN : 100VAC

DATE: SEPT 12, 2008

LOAD (%)	LIFETIME (YRS)				
	Ta = 30°C	Ta = 40°C	Ta = 50°C	Ta = 60°C	Ta = 70°C
25	52.4	26.2	13.1	5.6	2.0
60	43.1	21.6	10.8	4.2	
80	42.5	21.3	10.6		
100	38.9	19.4	9.0		

GRAPH OF ELECTROLYTIC CAPACITOR LIFETIME VS LOAD  
MOUNTING E KWD5-1212



### 計算式 FORMULA

1. アルミ電解コンデンサ  
AL. Electrolytic capacitor  
 $L = Lo \times 2^{(105-Tc)/10}$  (year)

L : 電解コンデンサ推定寿命計算値  
Elec. Capacitor computed life.  
(24時間連続稼動、365日)  
(24 hrs per day, 365 days per year)

2. OSコンデンサ  
O.S capacitor  
 $L = Lo \times 10^{(105-Tc)/22}$  (year)

Lo : 電解コンデンサ保証寿命値  
Guarantee life for Elec. cap.  
Tc : 電解コンデンサのケース温度  
Case temperature of Elec. cap.

## ELECTROLYTIC CAPACITOR LIFETIME VERSUS LOAD

MODEL : KWD5-1212

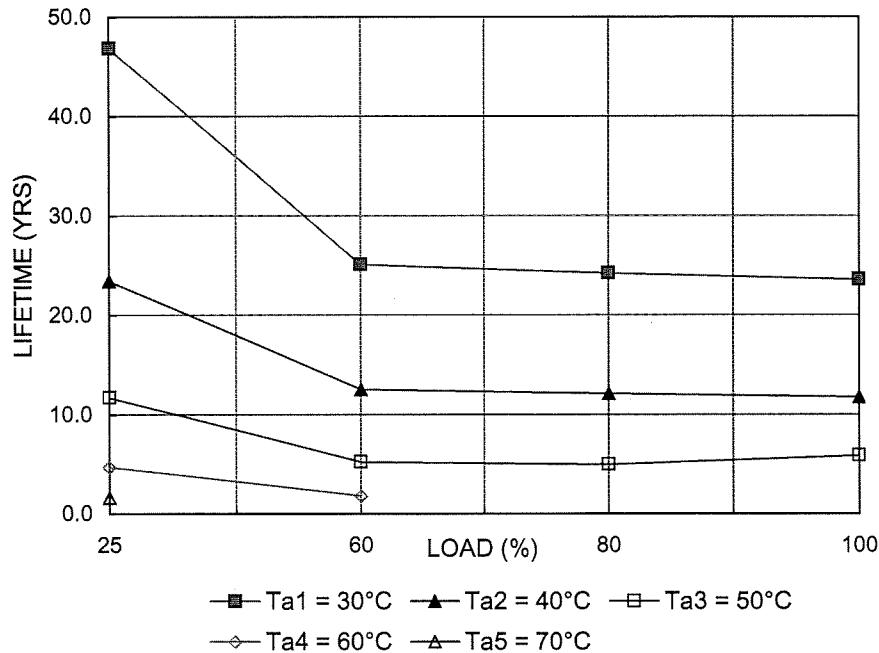
MOUNTING : A

VIN : 200VAC

DATE: SEPT 12, 2008

LOAD (%)	LIFETIME (YRS)				
	Ta = 30°C	Ta = 40°C	Ta = 50°C	Ta = 60°C	Ta = 70°C
25	46.9	23.4	11.7	4.72379684	1.65861564
60	25.1	12.6	5.2	1.84162118	
80	24.3	12.1	5.0		
100	23.6	11.8	5.9		

GRAPH OF ELECTROLYTIC CAPACITOR LIFETIME VS LOAD  
MOUNTING A KWD5-1212



### 計算式 FORMULA

1. アルミ電解コンデンサ  
AL. Electrolytic capacitor  
 $L = Lo \times 2^{(105-Tc)/10}$

$L$  : 電解コンデンサ推定寿命計算値  
Elec. Capacitor computed life.  
(24時間連続稼動、365日)  
(24 hrs per day, 365 days per year)

2. OSコンデンサ  
O.S capacitor  
 $L = Lo \times 10^{(105-Tc)/22}$

$Lo$  : 電解コンデンサ保証寿命値  
Guarantee life for Elec. cap.  
 $Tc$  : 電解コンデンサのケース温度  
Case temperature of Elec. cap.

## ELECTROLYTIC CAPACITOR LIFETIME VERSUS LOAD

MODEL : KWD5-1212

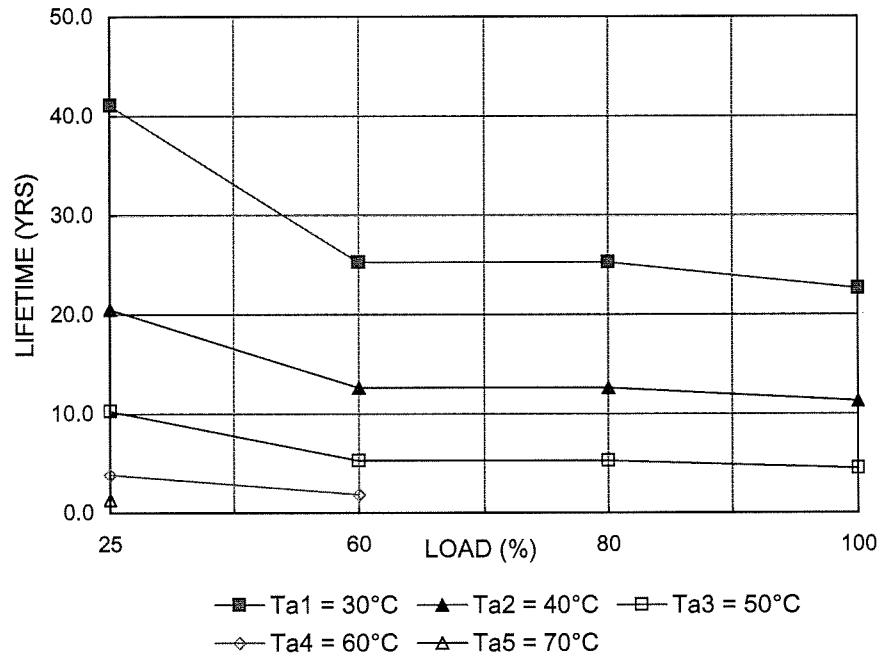
MOUNTING : B

VIN : 200VAC

DATE: SEPT 12, 2008

LOAD (%)	LIFETIME (YRS)				
	Ta = 30°C	Ta = 40°C	Ta = 50°C	Ta = 60°C	Ta = 70°C
25	41.1	20.5	10.3	3.9	1.4
60	25.3	12.6	5.3	1.9	
80	25.3	12.6	5.3		
100	22.6	11.3	4.5		

GRAPH OF ELECTROLYTIC CAPACITOR LIFETIME VS LOAD  
MOUNTING B KWD5-1212



### 計算式 FORMULA

1. アルミ電解コンデンサ  
AL. Electrolytic capacitor

$$L = Lo \times 2^{(105-Tc)/10} \quad (\text{year})$$

L : 電解コンデンサ推定寿命計算値

Elec. Capacitor computed life.

(24時間連続稼動、365日)

(24 hrs per day, 365 days per year)

2. OSコンデンサ

O.S capacitor

$$L = Lo \times 10^{(105-Tc)/22} \quad (\text{year})$$

Lo :

電解コンデンサ保証寿命値

Guarantee life for Elec. cap.

Tc : 電解コンデンサのケース温度

Case temperature of Elec. cap.

## ELECTROLYTIC CAPACITOR LIFETIME VERSUS LOAD

MODEL : KWD5-1212

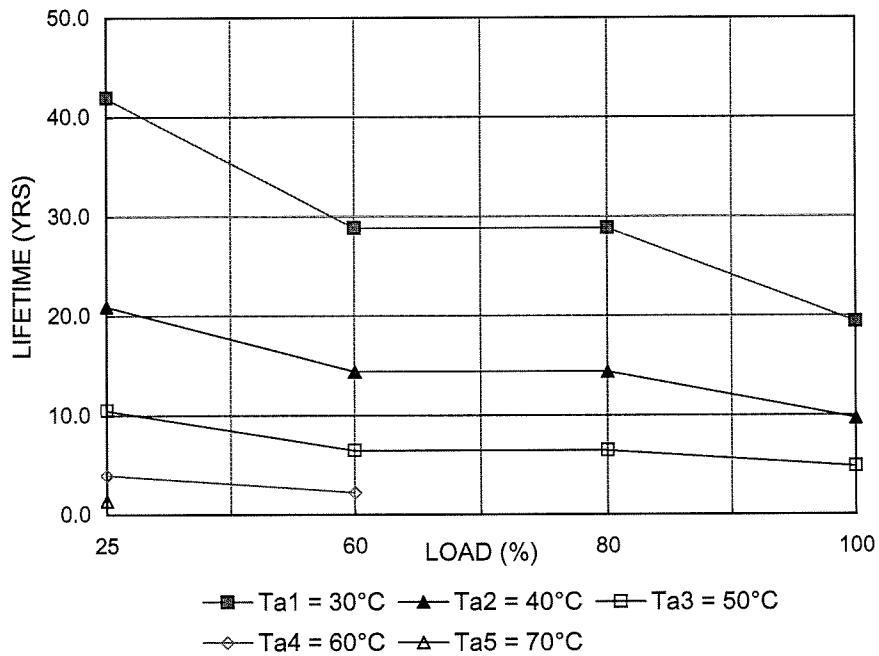
MOUNTING : C

VIN : 200VAC

DATE: SEPT 12, 2008

LOAD (%)	LIFETIME (YRS)				
	Ta = 30°C	Ta = 40°C	Ta = 50°C	Ta = 60°C	Ta = 70°C
25	42.0	21.0	10.5	4.0	1.4
60	28.9	14.4	6.5	2.3	
80	28.9	14.4	6.5		
100	19.4	9.7	4.9		

GRAPH OF ELECTROLYTIC CAPACITOR LIFETIME VS LOAD  
MOUNTING C KWD5-1212



### 計算式 FORMULA

1. アルミ電解コンデンサ  
AL. Electrolytic capacitor  
 $L = Lo \times 2^{(105-Tc)/10}$

L : 電解コンデンサ推定寿命計算値  
Elec. Capacitor computed life.  
(24時間連続稼動、365日)  
(24 hrs per day, 365 days per year)

2. OSコンデンサ  
O.S capacitor  
 $L = Lo \times 10^{(105-Tc)/22}$

Lo : 電解コンデンサ保証寿命値  
Guarantee life for Elec. cap.  
Tc : 電解コンデンサのケース温度  
Case temperature of Elec. cap.

## ELECTROLYTIC CAPACITOR LIFETIME VERSUS LOAD

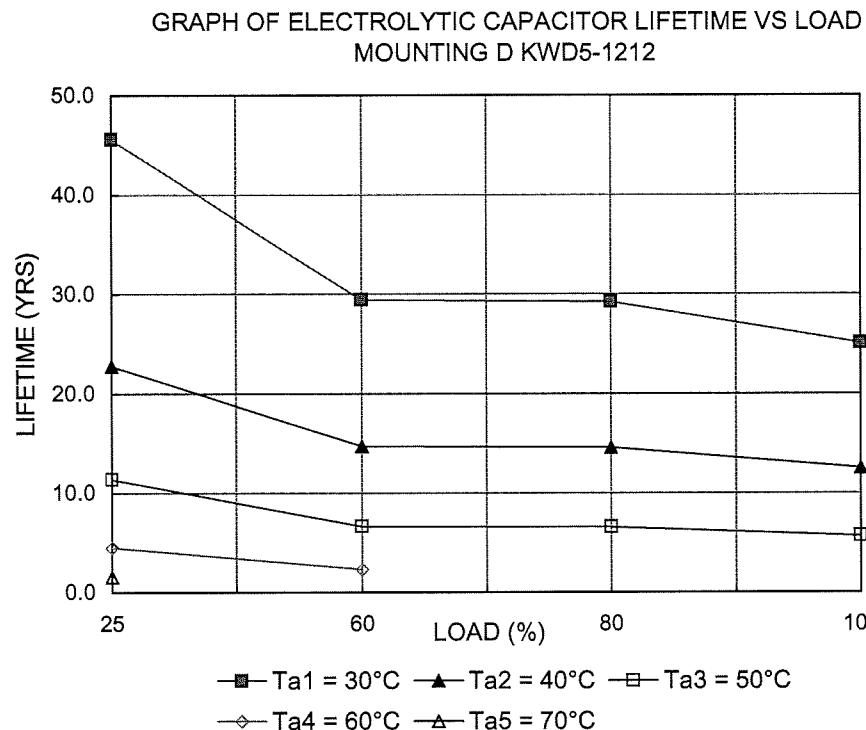
MODEL: KWD5-1212

MOUNTING : D

VIN : 200VAC

DATE: SEPT 12, 2008

LOAD (%)	LIFETIME (YRS)				
	Ta = 30°C	Ta = 40°C	Ta = 50°C	Ta = 60°C	Ta = 70°C
25	45.6	22.8	11.4	4.5	1.6
60	29.5	14.7	6.7	2.3	
80	29.3	14.6	6.6		
100	25.1	12.6	5.7		



### 計算式 FORMULA

- |  |  |
|--|--|
| 1. アルミ電解コンデンサ<br>AL. Electrolytic capacitor<br>$L = Lo \times 2^{(105-Tc)/10}$ | $L$ : 電解コンデンサ推定寿命計算値<br>Elec. Capacitor computed life.<br>(24時間連続稼動、365日)<br>(24 hrs per day, 365 days per year) |
| 2. OSコンデンサ<br>O.S capacitor<br>$L = Lo \times 10^{(105-Tc)/22}$                | $Lo$ : 電解コンデンサ保証寿命値<br>Guarantee life for Elec. cap.<br>$Tc$ : 電解コンデンサのケース温度<br>Case temperature of Elec. cap.   |

## ELECTROLYTIC CAPACITOR LIFETIME VERSUS LOAD

MODEL: KWD5-1212

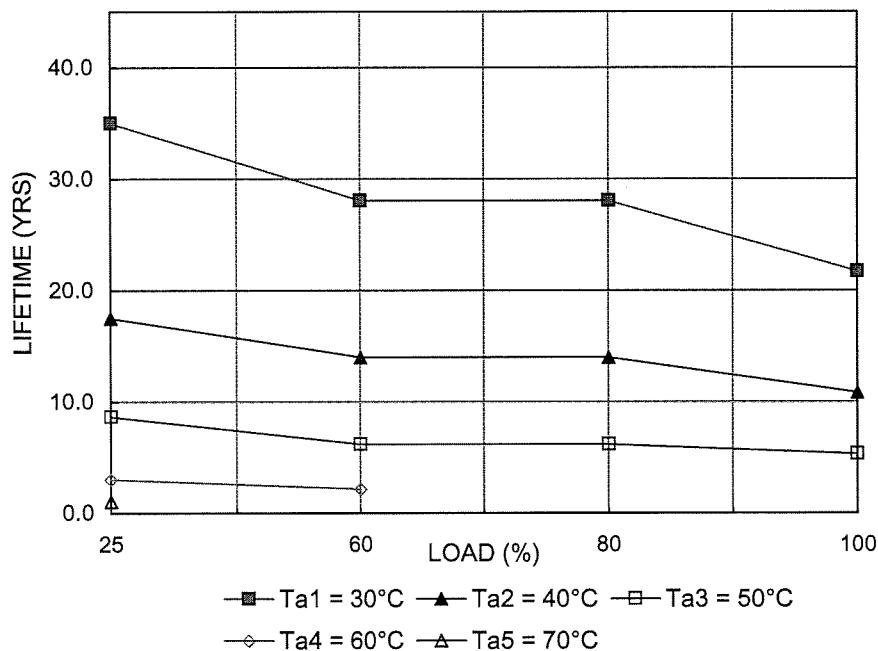
MOUNTING : E

VIN : 200VAC

DATE: SEPT 12, 2008

LOAD (%)	LIFETIME (YRS)				
	Ta = 30°C	Ta = 40°C	Ta = 50°C	Ta = 60°C	Ta = 70°C
25	35.0	17.5	8.7	3.0	1.1
60	28.1	14.0	6.2	2.2	
80	28.1	14.0	6.2		
100	21.7	10.9	5.4		

GRAPH OF ELECTROLYTIC CAPACITOR LIFETIME VS LOAD  
MOUNTING E KWD5-1212



### 計算式 FORMULA

1. アルミ電解コンデンサ  
AL. Electrolytic capacitor  
 $L = Lo \times 2^{(105-Tc)/10}$

$L$  : 電解コンデンサ推定寿命計算値  
Elec. Capacitor computed life.  
(24時間連続稼動、365日)  
(24 hrs per day, 365 days per year)

2. OSコンデンサ  
O.S capacitor  
 $L = Lo \times 10^{(105-Tc)/22}$

$Lo$  : 電解コンデンサ保証寿命値  
Guarantee life for Elec. cap.  
 $Tc$  : 電解コンデンサのケース温度  
Case temperature of Elec. cap.

MODEL : KWD5-1212		TEST CONDITIONS									
		ABNORMAL TESTING					LOAD = 100%				
PART NAME	PART NO.	TEST MODE	S	O	F	S	B	R	D	O	N
1 MOSFET	Q1	D-G	Y				A	U		O	O
2 2SK1533-4100		D-S	Y				M	S	C	O	O
3		G-S	Y				E	L	V	H	H
4		D	Y				T	O	P	T	A
5		S	Y				H	G	P	N	R
6		G	Y				E	W	.	G	S
7							T	N	.	T	E
8 TRANSISTOR	Q2	C-E	Y								
9 2SC2712-Y-TE85L		C-B	Y								
10		B-E	Y								
11		C	Y								
12		E	Y								
13		B	Y								
14											
15 I.C.	A1	1-2	Y								
16 UC2842ADW		2-3	Y								
17		3-4	Y								
18		4-5	Y								
19		5-6	Y								
20		6-7	Y								
21		7-8	Y								
22		9-10	Y								
23		10-11	Y								
24		11-12	Y								
25											

\*\*\* A : SUGHT B : PROLONGED

TDK-Lambda

MODEL : KWD5-1212		ABNORMAL TESTING												TEST CONDITIONS		DWG NO: PA773-57-03	
														APPROVED		TESTED	
														CCAV<sup>O</sup> ≥7%/ <sub>R</sub>			
PARTS NAME	PART NO.	TEST MODE		S	O	F	S	S	B	S	R	D	F	O	O	N	O
		H	P	I	M	M	M	R	E	D	M	S	C	V	O	O	O
1	A1	12-13	Y	O	E	R	O	K	S	L	A	E	U	H	H	A	E
2		13-14	Y	R	N	E	K	E	T	L	H	G	O	P	P	N	R
3		14-15	Y	T				E	T	O	E	W	.	U	T	G	S
4		15-16	Y											Y			
5			1											Y			
6			2											Y			
7			3											Y			
8			4											Y			
9			5											Y			
10			6											Y			
11			7											Y			
12			8											Y			
13			9											Y			
14			10											Y	Hiccup		
15			11											Q1,A1,R24,R25,R26,R17,R13.		Y	
16			12											Y		Y	
17			13											Y		Y	
18			14											Y		Y	
19			15											Y	Switching freq lower; output low	Y	
20			16											Y		Y	
21																	
22																	
23																	
24																	
25																	

\*\*\* A : SUGHT B : PROLONGED

TDK-Lambda

MODEL : KWD5-1212		ABNORMAL TESTING										TEST CONDITIONS		APPROVED		TESTED	
												LOAD = 100%		Vi <sub>in</sub> = 200VAC Ta = 25°C		CCNE-O 1703/83	
PARTS NAME	PART NO.	TEST MODE	S	O	F	S	B	S	R	D	F	O	O	N	O	R	N
1 SHUNT REGULATOR HA17431UA-TL	A2	K-A	Y												E	O	
2		K-R	Y												T	E	
3		R-A	Y												S	G	
4		K	Y												T	O	
5		A	Y													D	
6		R	Y														
7																	
8 PHOTO COUPLER TLP121GR-TPL	PC1	1-3	Y									Y	Y			Y	
9		4-6	Y									Y				Y	
10		1	Y									Y				Y	
11		3	Y									Y				Y	
12		4	Y									Y				Y	
13		6	Y									Y				Y	
14																	
15 CHIP BRIDGE S1WB(A)60B	D1	AC	Y									Y				Y	
16												Y				Y	
17		D1	DC	Y								Y				Y	
18		D1	DC	Y								Y				Y	
19																	
20 CHIP DIODE EC8FS6-TE12L	D2	A-K	Y									Y	Hiccup			Y	
21		A-K	Y									Y				Y	
22																	
23 CHIP DIODE ISS184-TE85L	D3	A-K	Y									Y				Y	
24		A-K	Y									Y				Y	
25																	

\*\*\* A : SIGHT B : PROLONGED

TDK-Lambda

21  
40

MODEL : KWD5-1212		ABNORMAL TESTING										TEST CONDITIONS				APPROVED		TESTED	
												LOAD = 100%		Vin = 200VAC		Ta = 25°C		CC/CEO 15703/93	
PARTS NAME	PART NO.	TEST MODE	S	O	F	S	S	B	R	D	F	O	O	N	O	R	E	N	
			H	P	I	M	M	U	M	E	A	O	O	C	T	O	E		
1	ISS184-TE85L	D4	A-K	Y													K	G	
2		A-K	Y														S	O	
3																	T	O	
4	CHIP DIODE	D5	A-K	Y														D	
5	D1FL20U	A-K	Y																
6																			
7	CHIP DIODE	D6	A-K	Y															
8	D1FL20U	A-K	Y																
9																			
10	CHIP DIODE	D7	A-K	Y															
11	D1FL20U	A-K	Y																
12																			
13	NOT ASSIGNED	D8																	
14																			
15																			
16	NOT ASSIGNED	D9																	
17																			
18																			
19	CHIP DIODE	D10	A-K	Y															
20	D1FL20U	A-K	Y																
21																			
22	CHIP DIODE	D11	A-K	Y															
23	D1FL20U	A-K	Y																
24																			
25																			

\*\*\* A : SUGHT B : PROLONGED

TDK-Lambda

22  
40

MODEL : KW5-1212		ABNORMAL TESTING												TEST CONDITIONS		DWG NO: PA773-57-06	
														LOAD = 100%		Vin = 200VAC	
														Ta = 25°C		CCNEO 1/01/93	
PARTS NAME	PART NO.	TEST MODE	S	O	F	S	S	B	S	R	D	F	O	O	N	O	NOTE
1	NOT ASSIGNED	D12	H	P	I	M	M	U	M	E	A	U	O	O	O	R N E O T	
2			O	E	R	O	K	R	E	D	M	S	C	V	O U H A E	T E G S O T D	
3			R	N	E	K	E	E	T	L	A	E	L	.	T A E		
4	NOT ASSIGNED	D13	A	-K						G	O	W	P	P	P N R G S		
5			A	-K						O	E	T	.	U	T E		
6																	
7	ZENER DIODE	ZD1	A	-K												Hiccup	
8	1N474A		A	-K												Y	
9			A	-K												Y	
10	CHIP ZENER	ZD2	A	-K												Y	
11	02CZ12Z-TE85L		A	-K												Y	
12			A	-K													
13																	
14																	
15																	
16																	
17																	
18																	
19																	
20																	
21																	
22																	
23																	
24																	
25																	

\*\*\* A : SUGHT B : PROLONGED

TDK-Lambda

MODEL : KWD5-1212		ABNORMAL TESTING										TEST CONDITIONS		APPROVED		TESTED	
												LOAD = 100%		Vin = 200VAC		Ta = 25°C	
PARTS NAME	PART NO.	S	O	F	S	S	B	S	R	D	F	O	O	N	N	R	N
1 CAP. FILM	C1	H	P	I	M	M	U	M	E	A	U	O	O	C	T	E	
2 MKC-S683M		O	E	R	O	K	R	E	L	A	G	V	U	H	H	O	
3		R	N	E	K	K	S	L	H	G	O	P	P	N	A	E	
4 CAP. CERAMIC	C2		Y						T	O	W	.	.	U	G	S	
5 ECKD NS221MB			Y						T	E	N	Y	Y	T	E	T	
6																	
7 NOT ASSIGNED	C3																
8																	
9 CAP. CERAMIC	C4		Y									Y	Y				
10 DET100F222MVA1N			Y									Y	Y				
11																	
12 CAP. CERAMIC	C5		Y									Y	Y				
13 DET100F222MVA1N			Y									Y	Y				
14																	
15 CAP. ELECT	C6		Y									Y					
16 LX400VBSN-27(M)			Y									Y					
17																	
18 CHIP CAP. CERAMIC	C7		Y											Y	Hiccup		
19 GR43-2W5R103K500FT			Y											Y			
20														Y			
21 CHIP CAP. CERAMIC	C8		Y											Y			
22 C3216X7R1E104KT			Y											Y			
23																	
24 CHIP CAP. CERAMIC	C9		Y											Y			
25 GR40B472K50PT			Y											Y			

\*\*\* A: SUGHT B: PROLONGED

TDK-Lambda

MODEL : KWD5-1212		ABNORMAL TESTING										TEST CONDITIONS		DWG NO: PA773 -57-08	
												LOAD = 100%		APPROVED TESTED	
												Vin = 200VAC		CC/NZC-O. ≥7/10/93	
		TEST MODE													
	PARTS NAME	PART NO.	S	O	F	S	B	R	D	F	O	N	N	R	N
		H	P	I	M	M	U	M	A	U	O	O	O	E	O
		O	E	R	O	K	R	E	E	S	C	V	U	T	G
		R	N	E	E	E	K	E	T	A	O	O	T	S	O
		T	T	T	T	T	L	L	H	G	P	P	U	O	T
1	CHIP CAP. CERAMIC	C10		Y											
2	C55Y5U1E186Z-TE12			Y											
3															
4	NOT ASSIGNED	C11													
5															
6															
7	CHIP CAP. CERAMIC	C12		Y											
8	C3225COG1H332JT			Y											
9															
10	CHIP CAP. CERAMIC	C13													
11	C2012COG1H101KT			Y											
12															
13	CHIP CAP. CERAMIC	C14		Y											
14	C2012X7R1H223KT			Y											
15															
16	CHIP CAP. CERAMIC	C15		Y											
17	C2012COG1H101KT			Y											
18															
19															
20	CHIP CAP. CERAMIC	C16		Y											
21	CM21W5R271K200BT			Y											
22															
23	CHIP CAP. CERAMIC	C17		Y											
24	C25Y5U1E106Z			Y											
25															

\*\*\* A : SUGHT B : PROLONGED

TDK-Lambda

25  
40

MODEL : KW5D5-1212		ABNORMAL TESTING												TEST CONDITIONS		DWG NO: PA773-57-09	
														LOAD = 100%		V <sub>in</sub> = 200VAC	
														T <sub>a</sub> = 25°C		APPROVED TESTED	
PARTS NAME	PART NO.	TEST MODE												NOTE	R	N	
1 O.S CAP	C18	S	O	F	S	S	B	S	R	D	F	O	O	N	O	E	
2 20SA33M+H		H	P	I	M	M	U	M	E	A	U	O	O	C	H	O	
3		O	E	R	O	K	R	E	D	M	S	V	O	O	T	E	
4 CHIP CERAMIC CAP.	C19	R	N	E	K	K	S	L	A	E	L	P	P	T	A	G	
5 CM21W5R271K200BT		T	T	E	E	E	T	T	H	G	O	.	.	U	N	S	
6									O	E	W	.	.	T	E	T	
7 CHIP CERAMIC CAP	C20								T							D	
8 C25Y5U1E106Z																	
9																	
10 O.S. CAP	C21																
11 20SA33M+H																	
12																	
13 CAP. CERAMIC	C22																
14 DE7100F222MVA1N																	
15																	
16 CHIP CERAMIC CAP	C23																
17 C2012X7R1H223KT																	
18																	
19																	
20																	
21																	
22																	
23																	
24																	
25																	

\*\*\* A : SIGHT. B : PROLONGED

TDK-Lambda

26  
fo

MODEL : KWD5-1212		ABNORMAL TESTING		TEST CONDITIONS		DWG NO: PA773-57-10	
				LOAD = 100%		APPROVED TESTED	
				Vin = 200VAC		CC/NEO 15%/ $\pm$ 3%	
PARTS NAME	PART NO.	TEST MODE					NOTE
1 CHIP RESISTOR ERJ8GEYJ514V	R1	Y					
4 CHIP RESISTOR ERJ8GEYJ514V	R2	Y					
5 CHIP RESISTOR ERJ8GEYJ514V	R3	Y					
6 CHIP RESISTOR ERJ8GEYJ514V	R4	Y					
7 CHIP RESISTOR ERJ8GEYJ514V	R5	Y					
8 CHIP RESISTOR ERJ8GEYJ514V	R6	Y					
9 METAL O. RESISTOR ERG1SJ-623	R7	Y					
10 METAL O. RESISTOR ERG1SJ-623	R8	Y					
11 METAL O. RESISTOR ERG1SJ-623	R9	Y					
12 METAL O. RESISTOR ERG1SJ-623	R10	Y					
13 METAL O. RESISTOR ERG1SJ-623	R11	Y					
14 METAL O. RESISTOR ERG1SJ-623	R12	Y					
15 CHIP RESISTOR ERJ8GEYJ823V	R13	Y					
16 CHIP RESISTOR ERJ8GEYJ823V	R14	Y					
17 CHIP RESISTOR ERJ8GEYJ823V	R15	Y					
18 CHIP RESISTOR ERJ8GEYJ823V	R16	Y					
19 CHIP RESISTOR ERJ8GEYJ823V	R17	Y					
20 CHIP RESISTOR ERJ8GEYJ823V	R18	Y					
21 CHIP RESISTOR ERJ8GEYJ823V	R19	Y					
22 CHIP RESISTOR ERJ8GEYJ823V	R20	Y					
23 CHIP RESISTOR ERJ8GEYJ823V	R21	Y					
24							
25							

\*\*\* A : SLIGHT B : PROLONGED

TDK-Lambda

27  
40

MODEL : KWD5-1212		TEST CONDITIONS		TEST CONDITIONS	
		LOAD = 100%		Vin = 200VAC Ta = 25°C	
		ABNORMAL TESTING		APPROVED TESTED	
PARTS NAME	PART NO.	TEST MODE			
1 CHIP RESISTOR ERJ8GEYJ823V	R9	Y	S O F H P I R O N T	S M U R E S L E A E G O E T A B	D F A U S B C V P .
2					
3					
4 NOT ASSIGNED	R10	Y			
5					
6					
7 NOT ASSIGNED	R11				
8					
9					
10 NOT ASSIGNED	R12				
11					
12					
13 CHIP RESISTOR CR1/10W330JV	R13	Y			
14					
15					
16 CHIP RESISTOR CR1/10W2211DV	R14	Y			
17					
18					
19 CHIP RESISTOR CR1/10W152JV	R15	Y			
20					
21					
22 CHIP RESISTOR CR1/10W331JV	R16	Y			
23					
24					
25					

\*\*\* A : SUGHT B : PROLONGED

TDK-Lambda

MODEL : KWD5-1212		ABNORMAL TESTING										TEST CONDITIONS.										
												LOAD = 100%					V <sub>in</sub> = 200VAC					
																	Ta = 25°C					
PARTS NAME	PART NO.	TEST MODE	S	O	F	S	S	B	R	D	F	O	O	N	N	O	R	N	E	T	G	
H	P	H	H	E	R	M	M	U	M	A	U	O	O	O	O	O	E	O	K	S	T	
O	E	O	O	E	E	O	O	R	E	M	S	B	C	V	C	H	E	T	E	G	O	
R	N	R	R	N	E	K	K	S	L	A	E	L	.	.	U	A	N	S	O	T	O	
T	T	T	T	E	E	E	E	T	L	H	G	O	P	P	P	N	R	E	T	G	D	
										O	E	W	.	.	U	G	S					
										T	N	.	.	T	E							
1	CHIP RESISTOR	R17	Y																			
2	ERJ8GEYJ100V		Y																			
3																						
4	CHIP RESISTOR	R18	Y																			
5	ERJ8GEYJ390V		Y																			
6																						
7	CHIP RESISTOR	R19	Y																			
8	CR1/10W272JV		Y																			
9																						
10	CHIP RESISTOR	R20	Y																			
11	ERJ8GEYJ100V		Y																			
12																						
13	CHIP RESISTOR	R21	Y																			
14	ERJ8GEYJ100V		Y																			
15																						
16	NOT ASSIGNED	R22																				
17																						
18																						
19	CHIP RESISTOR	R23	Y																			
20	CR1/10W183JV		Y																			
21																						
22	CHIP RESISTOR	R24	Y																			
23	ERJ8GEYJ7R5V		Y																			
24																						
25																						

\*\*\* A : SUGHT B : PROLONGED

TDK-Lambda

29  
46

MODEL : KWD5-1212		ABNORMAL TESTING										TEST CONDITIONS		APPROVED		TESTED	
												LOAD = 100%		Vin = 200VAC		Ta = 25°C	
PARTS NAME	PART NO.	TEST MODE	S	O	F	S	S	B	R	D	F	O	O	N	O	R	N
			H	P	I	M	M	U	M	E	A	U	O	O	C	E	
			O	E	R	O	O	R	E	D	M	S	B	C	T	O	
			T	N	E	K	K	L	A	A	E	L	G	V	E	O	
						E	E	T	L	H	G	O	P	P	T	E	
									O	E	T	W	.	U	N	R	
									T	T	N	.	.	T	G	S	
1	CHIP RESISTOR	R25															
2	ERJ8GEYJ7R5V																
3																	
4	CHIP RESISTOR	R26															
5	ERJ8GEYJ7R5V																
6																	
7	CHIP RESISTOR	R27															
8	ERJ8GEYJ300V																
9																	
10	CHIP RESISTOR	R28															
11	ERJ8GEYJ300V																
12																	
13	NOT ASSIGNED	R29															
14																	
15																	
16	NOT ASSIGNED	R30															
17																	
18																	
19	CHIP RESISTOR	R31															
20	ERJ8GEYJ132V																
21																	
22	CHIP RESISTOR	R32															
23	ERJ8GEYJ132V																
24																	
25																	

\*\*\* A : SUGHT B : PROLONGED

TDK-Lambda

MODEL : KWD5-1212		ABNORMAL TESTING		TEST CONDITIONS		LOAD = 100%		V <sub>in</sub> = 200VAC		T <sub>a</sub> = 25°C		C/N/E-O 1/7/03/93	
		TEST MODE		PART NO.		S O F S S R D F O O N O C T H A E		S M M U M E D W A E L O P U H G P N R		S M M U M E D W A E L O P U H G P N R		R N E O G S O T O D	
				H P E R O K S L A E U M S B C V O O O C T H A E		H P E R O K S L A E U M S B C V O O O C T H A E		H P E R O K S L A E U M S B C V O O O C T H A E		H P E R O K S L A E U M S B C V O O O C T H A E		R N E O G S O T O D	
1	CHIP RESISTOR	R33	Y	O N E R T		O N E R T		O N E R T		O N E R T		O N E R T	
2	ERJ8GEYJ300V		Y										Y
3													Y
4	CHIP RESISTOR	R34	Y										Y
5	ERJ8GEYJ300V		Y										Y
6													
7	NOT ASSIGNED	R35											
8													
9													
10	NOT ASSIGNED	R36											
11													
12													
13	CHIP RESISTOR	R37	Y										
14	ERJ8GEYJ132V		Y										
15													
16	CHIP RESISTOR	R38	Y										
17	ERJ8GEYJ132V		Y										
18													
19	CHIP RESISTOR	R39	Y										
20	ERJ8GEYJ102V		Y										
21													
22	CHIP RESISTOR	R40	Y										
23	CRI/10W222JV		Y										
24													
25													

\*\*\* A : SLIGHT B : PROLONGED

TDK-Lambda

48

TDK-Lambda

MODEL : KWD5-1212		ABNORMAL TESTING										TEST CONDITIONS		LOAD = 100%		V <sub>in</sub> = 200VAC		T <sub>a</sub> = 25°C		DWG NO: PA773-57-15 APPROVED TESTED <i>CCNEO 27/10/93</i>	
		TEST MODE																			
PARTS NAME	PART NO.	S	O	F	S	S	B	R	D	F	O	O	N	N	O	O	R	N	E	O	
		H	P	I	M	M	U	M	A	U	O	O	O	O	O	O	T	K	E	G	
		O	E	R	O	O	R	E	E	L	V	U	U	U	U	U	S	S	S	O	
		R	N	E	K	K	S	L	A	E	C	O	P	P	T	A	T	T	T	O	
		T	T	E	E	E	T	L	H	G	W	W	W	W	U	G	E	E	E	D	
1	CHIP RESISTOR CR1/10W7681DV	R41			Y											Y				Y	
2																					
3																					
4	CHIP RESISTOR CR1/10W1742DV	R42			Y											Y				Y	
5																Y				Y	
6																					
7	CHIP RESISTOR CR1/10W2001DV	R43			Y											Y				Y	
8																					
9																					
10	TRANSFORMER	T1			1-2	Y											Y				
11	PA77301		3-4	Y												Y				Y	
12			5-6	Y												Y				Y	
13			5-7	Y												Y				Y	
14			6-7	Y												Y				Y	
15			1	Y												Y				Y	
16			2	Y												Y				Y	
17			3	Y												Y				Y	
18			4	Y												Y				Y	
19			5	Y												Y				Y	
20			6	Y												Y				Y	
21			7	Y												Y				Y	
22																					
23																					
24																					
25																					

\*\*\* A : SUGGET B : PROLONGED

32  
46

MODEL : KW5-1212		ABNORMAL TESTING										TEST CONDITIONS		DWG NO: PA773-57-16			
												LOAD = 100%		V <sub>in</sub> = 200VAC			
												Ta = 25°C		C/N<sub>O</sub>			
PARTS NAME	PART NO.	TEST MODE		S	O	F	S	S	B	S	R	D	F	O	O	N	O
		H	P	I	M	M	E	M	A	U	D	M	S	O	O	C	T
		O	E	R	O	O	R	E	E	L	A	E	L	V	U	H	H
		R	N	E	K	K	E	S	L	G	M	S	O	P	T	A	E
		T	T	E	E	E	T	T	H	A	A	E	W	.	U	N	R
1	BALUN COIL	L1	1-2	Y													
2	UF1717H-123YR15-02		3-4	Y													
3			1	Y													
4			2	Y													
5			3	Y													
6			4	Y													
7																	
8	CHIP COIL	L4															
9	LQH3C2R2M04																
10																	
11	NOT ASSIGNED	L5															
12																	
13																	
14	CHIP COIL	L6															
15	LQH3C2R2M04																
16																	
17	NOT ASSIGNED	L7															
18																	
19																	
20																	
21																	
22																	
23																	
24																	
25																	

\*\*\* A : SLIGHT B : PROLONGED

TDK-Lambda

VIBRATION TEST

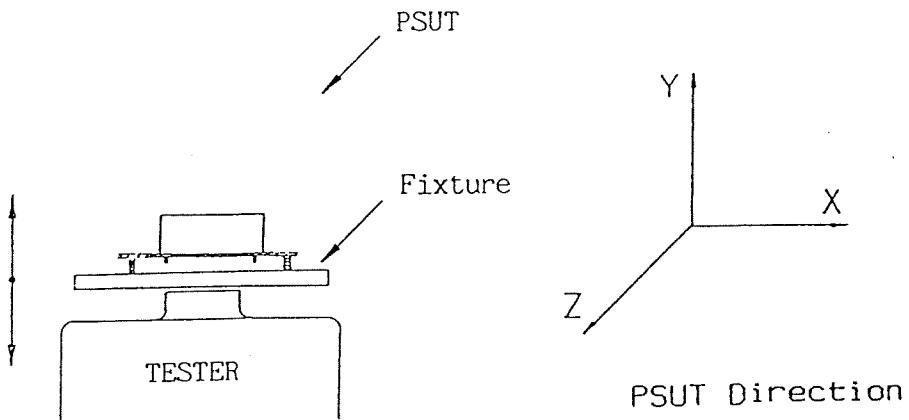
## TYPES OF VIBRATION TEST :

- A) OSCILLATOR FREQUENCY SWEEP
- B) RESONANCE FREQUENCY

EQUIPMENT : EMIC CORPORATION VIBRATION TEST SYSTEM  
VIBRATION GENERATOR

F-400-BM-E47  
905-FN

## PROCEDURE :



## VIBRATION TEST WITH FREQUENCY SWEEP

FREQUENCY	10 ~ 55 Hz.
SWEEP TIME	1 min.
ACCELERATION	MAX 10G.
AMPLITUDE	1.65mm <sup>PP</sup> CONSTANT.
DIRECTION	X, Y, Z.
DURATION	1 hr. for each direction.

## TEST POINT :

1. Output voltage (Apply some shock when checking the o/p voltage, and observe any abnormalities.)
2. Ripple voltage (At AC 100V input and output)
3. Mechanical Condition (No breakage)

認 APPD	<i>S. J. K.</i> 5/MAR/93	設 計 ENGR	<i>J. L. Key</i> 27 · NOV · 92	図面番号 D WG-No.
検 図 C H K	<i>C CNEO</i> 30 · DEC · 92	製 図 D WG	<i>WILLIAM PHIN</i> 25 · NOV · 92	PA773-64-01

DATE

TEST RESULTS :  
(after vibration)

TEST POINT	OUTPUT VOLTAGE (V)			RIPPLE VOLTAGE (mV)			MECHANICAL CONDITION	NOTE
	CH1	CH2	CH3	CH1	CH2	CH3		
BEFORE DIRECT TEST	11.818	11.781	—	20	20	—	O.K.	
X	11.817	11.778	—	20	20	—	O.K.	
Y	11.820	11.776	—	20	20	—	O.K.	
Z	11.827	11.771	—	20	20	—	O.K.	

EVALUATION RESULT :



/ FAIL

VISUAL INSPECTION RESULT :

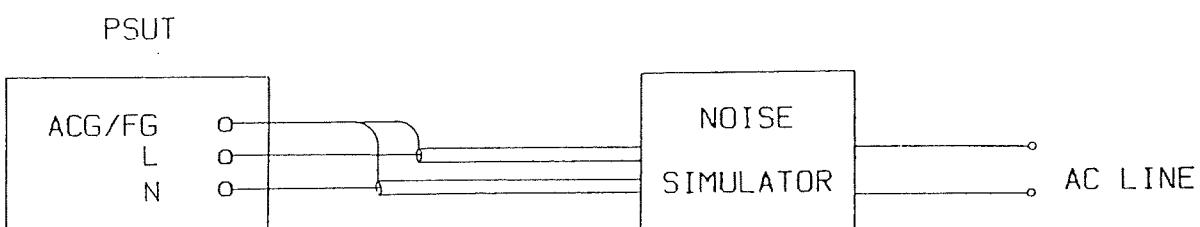


/ FAIL

認 APPD	.	設計 ENGR	.	図面番号 DWG-No.	
検 CHK	.	製 DWG	.		

NOISE SIMULATION TEST

Circuit for measurement and equipment used :



MODEL : ENS-24X (SANKI)

## Testing Conditions :

Input Voltage : AC100V

Output Voltage : Rated

Output Current : 0% , 100%

Ambient Temp. : 25 °C

## Settings :

MODE ..... Normal , Common

TRIG SELECT .... Line or Ext (Line)

PULSE WIDTH .... 50, 200, 800, 1000ns

PHASE SHIFT .... 0 ~ 360 Degree

POLARITY ..... + , -

NOISE LEVEL .... 0 ~ 2KV

## Acceptance Criteria :

- 1) No damage of PSUT
- 2) No output failure  
(eg. Over/Uundershoot < 3% of Vo)
- 3) Check any abnormalities (eg. noise)

## Evaluation Result :

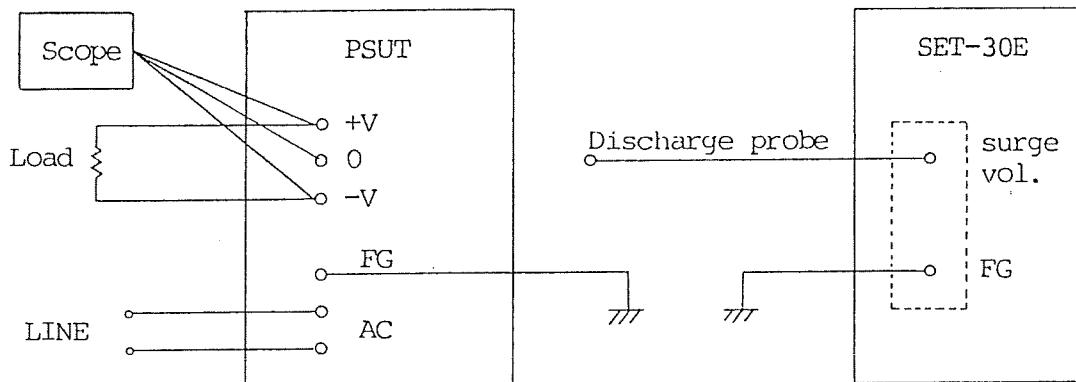
PASS

/ FAIL

認 APPD	<i>John</i> 11·MAR·93	設 計 ENGR	<i>John</i> 12·1·93	図面番号 DWG-No.
検 図 C H K	<i>CCNEO</i> 15·1·93	製 図 DWG	<i>Ranaymin</i> 12·1·93	PA773-61-01 - <input type="checkbox"/>

ELECTROSTATIC DISCHARGE TEST

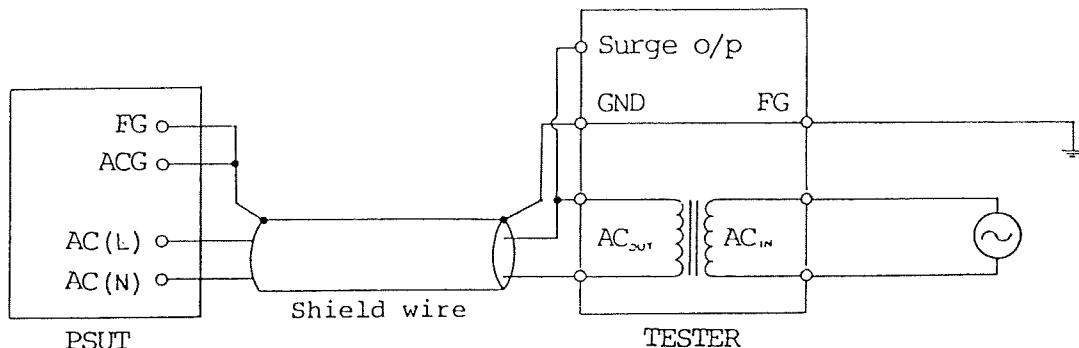
EQUIPMENT : SET-30E (SANKI ELECTRONIC)

Discharge Resistor : 250 ohm  
Capacitor unit : 200 pFCONDITIONS : Ambient Temperature : 25°C  
Input Voltage : AC100V  
Output Voltage : Rated  
Output Current : Rated  
Applied Voltage : ±3kV, ±5kV, ±10kV, ±15kVPROCEDURE :  
The PSUT should be in a good working condition.  
Discharge the applied voltage to the touchable parts of the PSUT (Chassis, Input Terminal, Output Terminal, FG Terminal, ACG Terminal) and check any abnormalities.  
  
Each point to be tested 3 times with different polarity. Voltage should be applied from 3kV to 15kV.ACCEPTANCE CRITERIA :  
1. No damage of PSUT  
2. No output failure ( $\Delta V_o < 3\% \text{ of } V_o$ )  
3. No abnormalitiesEVALUATION RESULT : PASS / FAIL

認 APPD	<i>2/10/93</i>	設 計 ENGR	<i>PSU</i> 12.1.93	図面番号 DWG-No.
検 図 C H K	<i>CCNEO</i> 12.01.93	製 図 DWG	<i>Ramim-m</i> 12.1.93	PA773-62-01 -

LIGHTNING SURGE TEST

## TEST CIRCUIT, TEST EQUIPMENT

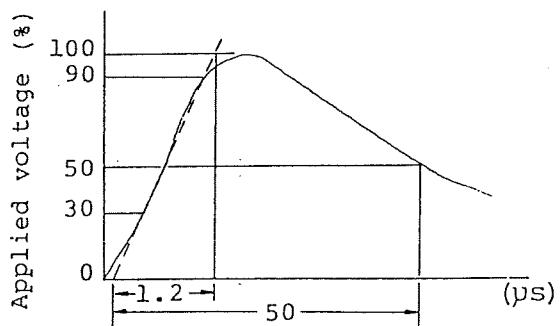


MODEL : LSG - 12K - E (SANKI)

CONDITIONS :

- Input Voltage : AC100V
- Output Voltage : Rated
- Output Current : Rated
- Applied Voltage : From 3kV in steps of 0.5kV  
Check the max. withstand voltage
- Applied Point : Between FG - AC
- Number of Test : Each voltage 3 times
- Polarity : +, -
- Ambient Temp. : 25°C

## APPLIED VOLTAGE WAVEFORM :



ACCEPTANCE CRITERIA :

1. No damage to the PSUT
2. No output failure
3. No abnormalities

EVALUATION RESULT :

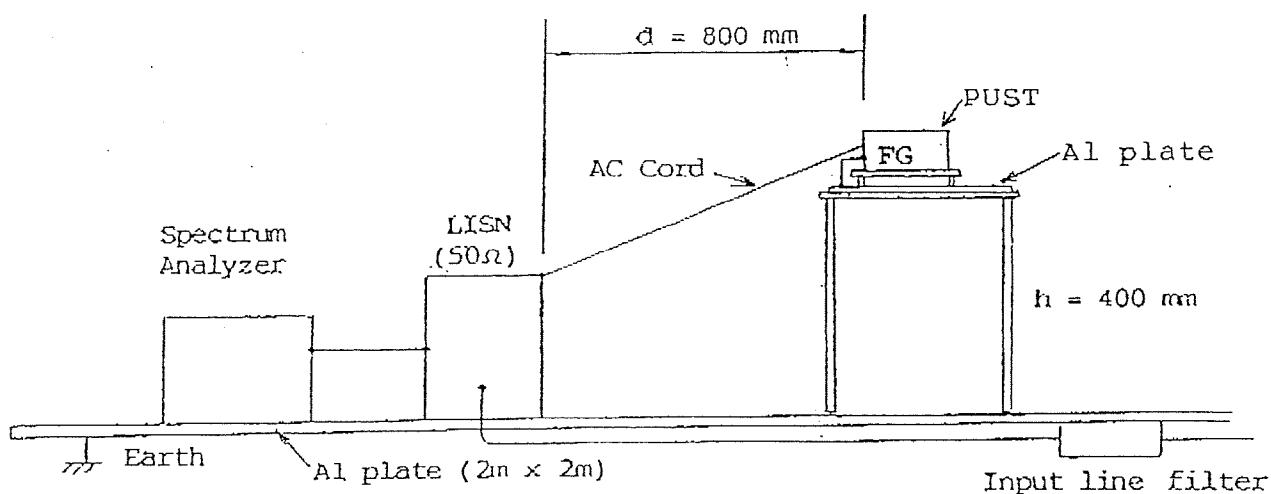
PASS  
5KV

/ FAIL

認. APPD	<i>[Signature]</i> 8 MAR '93	設計 ENGR	<i>psn</i> 12 · 1 · 93	図面番号 DWG-No.	PA773-74-01	-
検 図 C H K	CC NEO 12 · 01 · 93	製 図 DWG	Ramey-n 12 · 1 · 93			

EMI TEST

## TEST CIRCUIT :



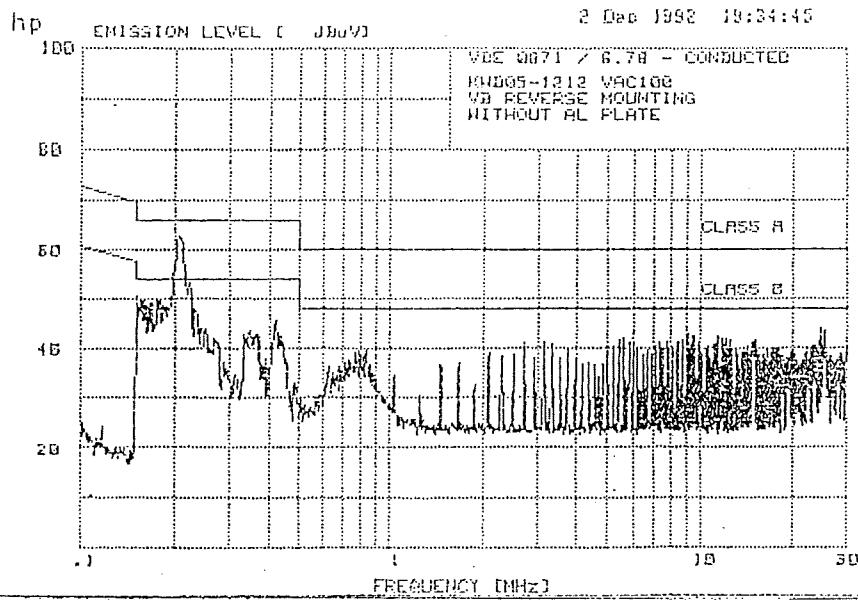
## TEST EQUIPMENTS :

SPECTRUM ANALYZER	8568B HEWLETT PACKARD
QUASI-PEAK ADAPTER	85650A HEWLETT PACKARD
RF PRESELECTOR	85685A HEWLETT PACKARD
LISH	3825/2 EMCO

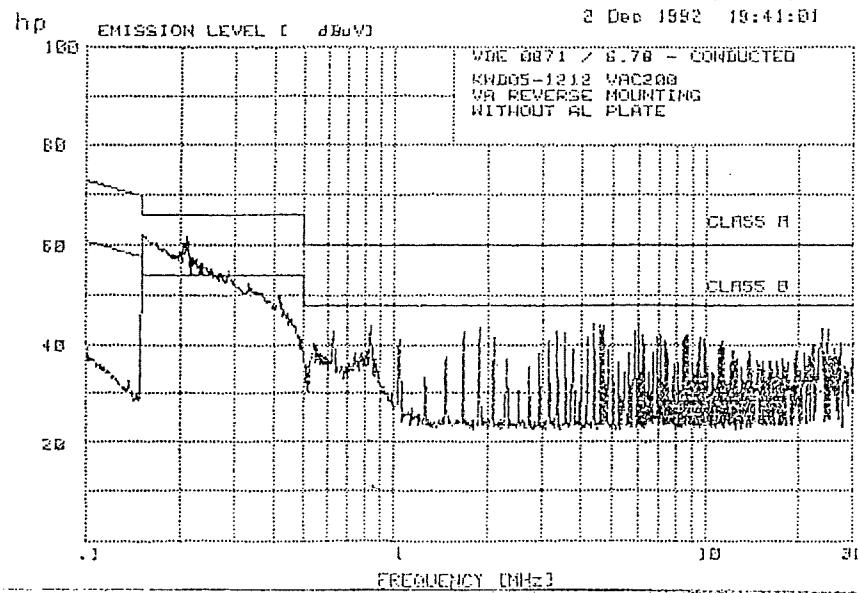
## CONDITIONS :

INPUT VOLTAGE	: AC100V, AC200V
OUTPUT VOLTAGE	: RATED
OUTPUT CURRENT	: RATED
AMBIENT TEMP	: 25°C

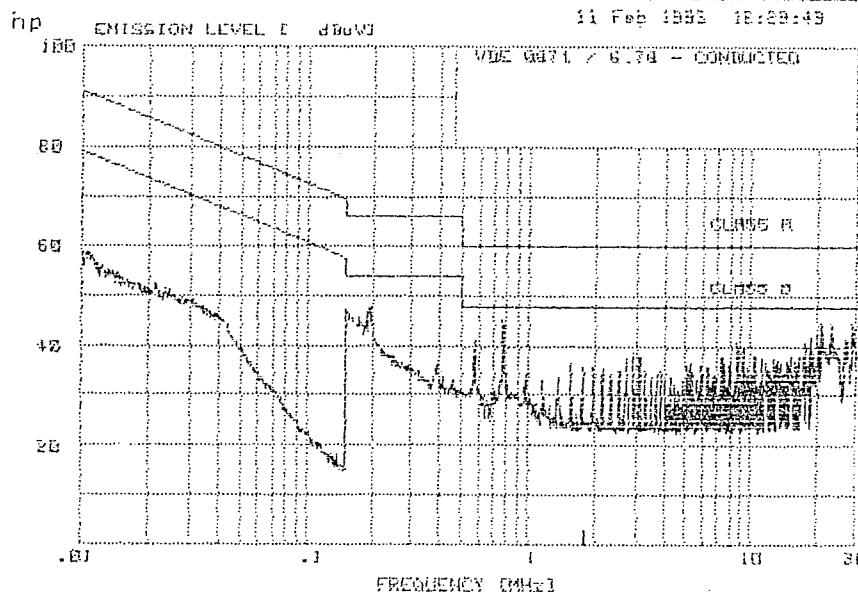
認 APPD		設 計 ENGR		図面番号 DWG-No.	
検 圖 CHK		製 圖 DWG			



Vin = 100Vac

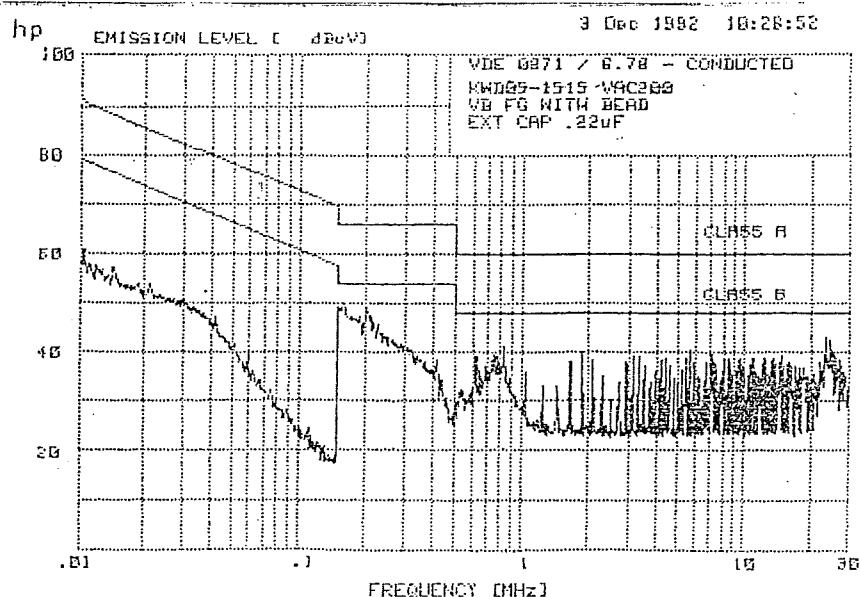
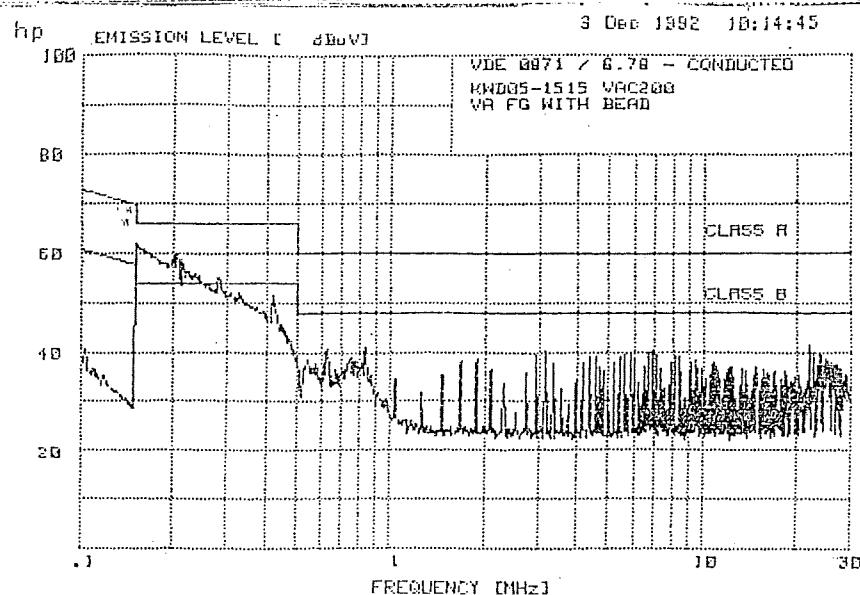
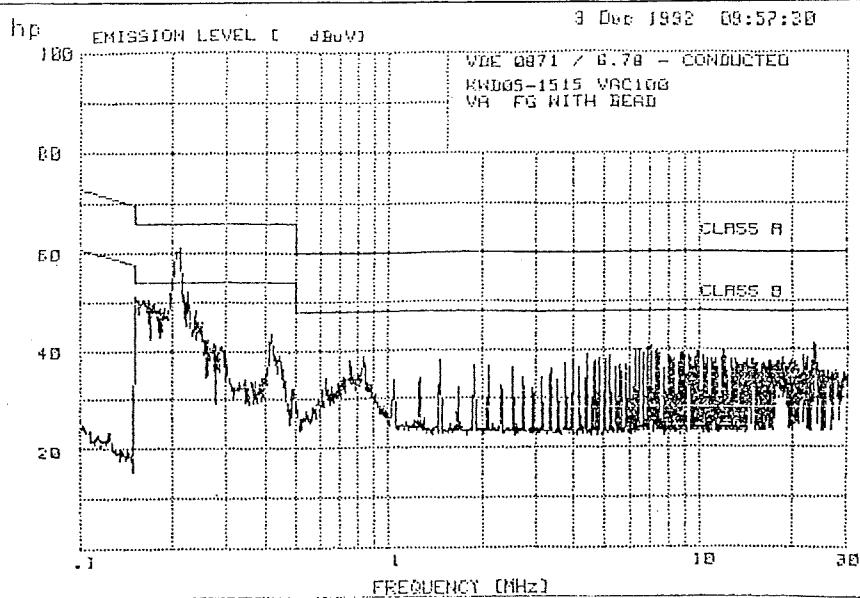


. Vin = 200Vac

Vin = 200Vac  
VDEwith external cap.  
0.22μF between  
AC(L) and AC(N)

認 APPD	.	設計 ENGR	.	図面番号 DWG-No.
検 CHK	.	製 DWG	.	PA773-70-02 -

DATE 15·MAR·1993



認 APPD	.	設 ENGR	.	図面番号 DWG-No.
検 CHK	.	製 DWG	.	PA773-70-03-